

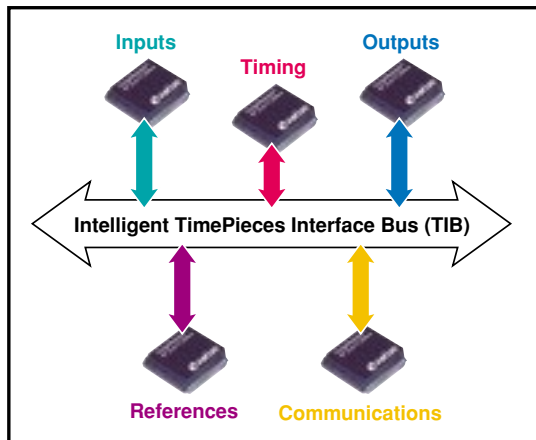
Parallel Communications Chip



Ordering P/N: TP413179-000-0

Description

The Parallel Communications chip is an advanced management interface to communicate with a customer Host system. It's part of the patent-pending TimePieces (TP) product family. It's designed with an intelligent TIB (Timepieces Interface Bus), which enables a set of TP chips to be seamlessly interconnected, controlled and managed on distributed customer boards.

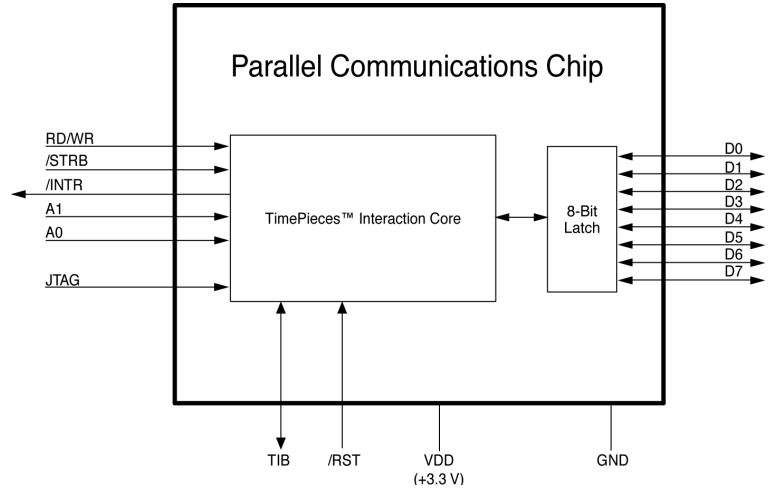


Features

- ✓ Communications interface between a customer Host system and a TP system
- ✓ TIB-based management interface
- ✓ Configuration, fault and performance monitoring of a TP system by a customer Host system
- ✓ Scalable to design a clock system with other TimePieces chips
- ✓ Designed for GR-63 (NEBS) equipment

Applications

- ✓ Multiservice clock controller & interface
- ✓ Multiservice ATM/IP/SONET/SDH equipment
- ✓ Transport/Switch/Router equipment
- ✓ Core/Metro/Edge/Access network equipment



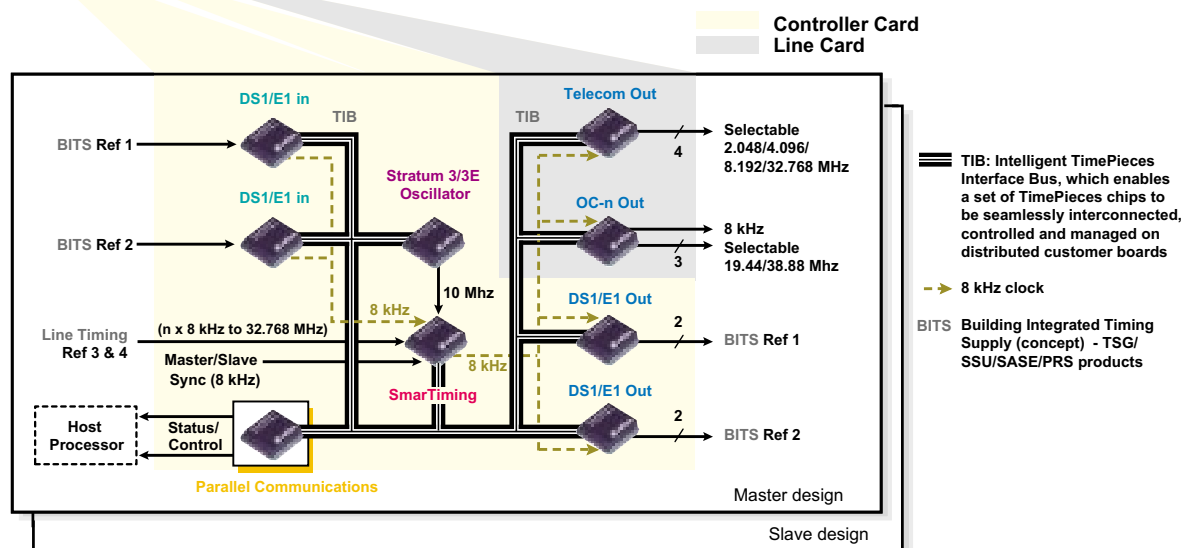
Key Parallel Communications Technical Specifications		
Interface	Customer Host system	8-bit memory mapped interface
Management Functionality	Configuration Monitoring	Customer Host system can configure a TP system Customer Host system can monitor faults & performance of a TP system
Standards Compliance		Latest GR-253/378/1244, ANSI T1.102/403 ITU-T
Size	Footprint Height	Standard 68-pin PLCC 0.44" (11.176 mm)
Power Supply	Input voltage (DC) Consumption	3.3 V (nominal) 130 mA
Environmental	Operating temperature Storage temperature Humidity	0 to 70° C -40° to 100° C 0 to 95% (no condensation)

Parallel Communications Chip



Typical Application Clock Controllers & Line Card Timing Interfaces

Multiservice
network element



The above configuration provides a fully operating Clock system with default settings to meet the standards specifications defined in GR-378/1244/253, ANSI T1.101/102/105 series/403, ITU-T G.703/704/812/813/823/824/825 and ETSI ETS 300 462 series. Connection to the Host processor is not required unless changes to default settings or monitoring is required.

Key Clock System Features & Capabilities		
Input	BITS (2x) Line timing (2x) Sync (1x) Auto selection/reverting	Selectable DS1/E1 (redundant) with SSM (Sync Status Message) data Selectable n x 8 kHz up to 32.768 MHz 8 kHz (Master/Slave protection mode for redundant design - 2 Clock/SmarTiming chips) Locking/reverting to the best qualified input reference
Output	BITS (4x) Telecom (4x) OC-n (4x)	Selectable DS1/E1 (redundant) with SSM data Selectable 2.048/4.096/8.192/32.768 MHz Selectable 1x 8 KHz and 3x 19.44/38.88 MHz
Clock Holdover	Oscillator	Stratum 3 or 3E
Hitless Clock Switching	Master/Slave clock switchover	Phase transient build-out during clock switchover
Jitter/Wander/Transient/Phase Filtering & Noise Transfer		See performance specifications of the SmarTiming chip
Real-Time Performance Monitoring	Input Reference qualification Historical data Retrieving Data	Up to 5 inputs, including Master/Slave Sync, settable or default priority selection Based on 1) frequency offsets; 2) stability offsets caused by jitter/wander (MTIE/TDEV thresholds); 3) DS1/E1 SSM; 4) telecom signal errors Frequency, phase, MTIE, TDEV data for performance and root-cause analysis Through the TIB (TimePieces Interface Bus)
Communications/Management	Parallel TIB	8 bit memory mapped interface TimePieces Interface Bus
Standards Compliance	Equipment (TimePieces inside)	Latest GR-253/378/1244, ANSI T1.101/102/105/403, ITU-T G.703/704/812/813/823/824/825, ETSI ETS 300 462 series